

L Number	Hits	Search Text	DB	Time stamp
1	2	(wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (pre\$1paint with seal\$3)	USPAT; EPO; JPO; DERWENT	2003/07/15 10:42
2	0	(wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (pre\$1paint with seal\$3)	USOCR	2003/07/15 09:44
3	0	(wood wooden cellulosic fiberboard fiber-board "fiber board" chipboard chip-board "chip board" particleboard particle-board "particle board" hardboard hard-board "hard board" flakeboard flake-board "flake board" strandboard strand-board "strand board" waferboard wafer-board "wafer board") and ((prepaint pre-paint "pre paint") with (seal sealed sealer sealant sealing))	USOCR	2003/07/15 09:46
4	70	(wood wooden cellulosic fiberboard fiber-board "fiber board" chipboard chip-board "chip board" particleboard particle-board "particle board" hardboard hard-board "hard board" flakeboard flake-board "flake board" strandboard strand-board "strand board" waferboard wafer-board "wafer board") and ("press coat" "press coated" "press coating") ("5059264").PN.	USOCR	2003/07/15 10:02
5	1	5059264.URPN.	USPAT	2003/07/15 10:20
6	16	5059264.URPN.	USPAT	2003/07/15 10:03
8	3	("3983307" "4017434" "4505986").PN.	USPAT	2003/07/15 10:03
9	16	5059264.URPN.	USPAT	2003/07/15 10:04
10	1	("5741823").PN.	USPAT	2003/07/15 10:41
11	31	("3098785" "3607341" "3790421" "3804700" "3901240" "3919451" "3933691" "3957940" "3961118" "4061822" "4238438" "4265965" "4289823" "4325856" "4376142" "4384096" "4385152" "4403003" "4510268" "4517228" "4654397" "4692473" "4734231" "4814373" "4966170" "5059264" "5063646" "5085891" "5109030" "5360826" "5436069").PN.	USPAT	2003/07/15 10:20
12	0	SHEETS-Harold[in]	USPAT; EPO; JPO; DERWENT	2003/07/15 10:42
13	1	SHEETS-Harold-J[in]	USPAT; EPO; JPO; DERWENT	2003/07/15 10:42
14	42	(wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and GLIDDEN[as]	USPAT; EPO; JPO; DERWENT	2003/07/15 10:43
15	13	(wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and GLIDDEN[as] and seal\$4	USPAT; EPO; JPO; DERWENT	2003/07/15 10:43
16	5	(wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and GLIDDEN[as] and seal\$4 and (primer primed multi\$1layer)	USPAT; EPO; JPO; DERWENT	2003/07/15 10:47
17	3	((wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and GLIDDEN[as] and seal\$4 and (primer primed multi\$1layer)) not 5059264[pn]	USPAT; EPO; JPO; DERWENT	2003/07/15 10:45
18	1	5059264[pn]	USPAT	2003/07/15 10:45
19	3	("3983307" "4017434" "4505986").PN.	USPAT	2003/07/15 10:45
20	16	5059264.URPN.	USPAT	2003/07/15 10:45

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21	35	(wood wooden cellulosic fiber\$1board chip\$1board particile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and HSU[in] and (primer primed multi\$1layer)	USPAT; EPO; JPO; DERWENT	2003/07/15 11:01
22	283	(wood wooden cellulosic fiber\$1board chip\$1board particile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (multi\$1layer same (ultra\$1violet "UV"))	USPAT; EPO; JPO; DERWENT	2003/07/15 11:02
23	135	(wood wooden cellulosic fiber\$1board chip\$1board particile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (multi\$1layer same (ultra\$1violet "UV")) and (primed primer sealed sealing sealant)	USPAT; EPO; JPO; DERWENT	2003/07/15 11:03
24	172	(wood wooden cellulosic fiber\$1board chip\$1board particile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (multi\$1layer same ((ultra\$1violet "UV") with cure cured curing)) and (primed primer sealed sealing sealant)	USPAT; EPO; JPO; DERWENT	2003/07/15 11:03
25	112	(wood wooden cellulosic fiber\$1board chip\$1board particile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (multi\$1layer same ((ultra\$1violet "UV") with cure cured curing)) and (sealed sealing sealant)	USPAT; EPO; JPO; DERWENT	2003/07/15 11:13
26	6	((("4072770") or ("4082882") or ("5212271") or ("5453451") or ("5584496") or ("5740941"))).PN.	USPAT	2003/07/15 11:11
27	1	("5453451").PN.	USPAT	2003/07/15 11:11
28	130	(wood wooden cellulosic fiber\$1board chip\$1board particile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (top\$1coat\$3 same ((ultra\$1violet "UV") with cure cured curing)) and (sealed sealing sealant)	USPAT; EPO; JPO; DERWENT	2003/07/15 11:14
29	125	(wood wooden cellulosic fiber\$1board chip\$1board particile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (top\$1coat\$3 same ((ultra\$1violet "UV") with cure cured curing)). and (sealed sealing sealant)	USPAT	2003/07/15 11:46
30	126	(wooden cellulosic fiber\$1board chip\$1board particile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (top\$1coat\$3 same ((ultra\$1violet "UV") with cure cured curing)) and (primed primer priming sealed sealing sealant)	USPAT	2003/07/15 11:50
31	52	(wooden fiber\$1board chip\$1board particile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (top\$1coat\$3 same ((ultra\$1violet "UV") with cure cured curing)) and (primed primer priming sealed sealing sealant)	USPAT	2003/07/15 12:12
32	690	(wooden fiber\$1board chip\$1board particile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and ((coating near3 line) (production near3 line))	USPAT	2003/07/15 12:16
33	14	((wooden fiber\$1board chip\$1board particile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and ((coating near3 line) (production near3 line))) and primer and top\$1coat\$3	USPAT	2003/07/15 12:13
34	140	(wooden fiber\$1board chip\$1board particile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (coating near3 line)	USPAT	2003/07/15 12:16

35	13	((wooden fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (coating near3 line)) and primer and top\$1coat\$3	USPAT	2003/07/15 12:16
36	0	((wooden fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (coating near3 line)) and primer and top\$1coat\$3) not (((wooden fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and ((coating near3 line) (production near3 line))) and primer and top\$1coat\$3)	USPAT	2003/07/15 12:16
37	127	((wooden fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (coating near3 line)) not (((wooden fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and ((coating near3 line) (production near3 line))) and primer and top\$1coat\$3)	USPAT	2003/07/15 12:17
-	4045	((427/258) or (427/369) or (427/370) or (427/371) or (427/407.1) or (427/408) or (427/412.2)).CCLS.	USPAT; EPO; JPO; DERWENT	2003/07/14 16:01
-	66	((427/258) or (427/369) or (427/370) or (427/371) or (427/407.1) or (427/408) or (427/412.2)).CCLS.) and (press\$3 near3 bond\$3)	USPAT; EPO; JPO; DERWENT	2003/07/14 16:01
-	26	((427/258) or (427/369) or (427/370) or (427/371) or (427/407.1) or (427/408) or (427/412.2)).CCLS.) and (press\$3 near3 bond\$3)) and (wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board)	USPAT; EPO; JPO; DERWENT	2003/07/14 16:25
-	9	((427/258) or (427/369) or (427/370) or (427/371) or (427/407.1) or (427/408) or (427/412.2)).CCLS.) and (press\$3 near3 bond\$3)) and (wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board)) and (coat\$3 near3 cur\$4)	USPAT; EPO; JPO; DERWENT	2003/07/14 16:22
-	2	((427/258) or (427/369) or (427/370) or (427/371) or (427/407.1) or (427/408) or (427/412.2)).CCLS.) and (press\$3 near3 bond\$3)) and (wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board)) and (coat\$3 near3 cur\$4)) and ("UV" ultra\$1violet) near3 cur\$4)	USPAT; EPO; JPO; DERWENT	2003/07/14 16:03
-	0	((427/258) or (427/369) or (427/370) or (427/371) or (427/407.1) or (427/408) or (427/412.2)).CCLS.) and (press\$3 near3 bond\$3)) and (wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board)) and (coat\$3 near3 cur\$4)) and ("UV" ultra\$1violet) near3 cur\$4)) and (primer primed priming)	USPAT; EPO; JPO; DERWENT	2003/07/14 16:03
-	2	((427/258) or (427/369) or (427/370) or (427/371) or (427/407.1) or (427/408) or (427/412.2)).CCLS.) and (press\$3 near3 bond\$3)) and (wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board)) and (coat\$3 near3 cur\$4)) and ("UV" ultra\$1violet) near3 cur\$4)) and (prime primer primed priming)	USPAT; EPO; JPO; DERWENT	2003/07/14 16:06
-	812	"press coating"	USPAT; EPO; JPO; DERWENT	2003/07/14 16:07
-	13	((427/258) or (427/369) or (427/370) or (427/371) or (427/407.1) or (427/408) or (427/412.2)).CCLS.) and "press coating"	USPAT; EPO; JPO; DERWENT	2003/07/14 16:07

-	7	(((((427/258) or (427/369) or (427/370) or (427/371) or (427/407.1) or (427/408) or (427/412.2)).CCLS.) and (press\$3 near3 bond\$3)) and (wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board)) and (coat\$3 near3 cur\$4)) not ((((((427/258) or (427/369) or (427/370) or (427/371) or (427/407.1) or (427/408) or (427/412.2)).CCLS.) and (press\$3 near3 bond\$3)) and (wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board)) and (coat\$3 near3 cur\$4)) and ("UV" ultra\$1violet) near3 cur\$4))	USPAT; EPO; JPO; DERWENT	2003/07/14 16:22
-	1122	((wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) with coat\$3) same ((press\$3 near3 coat\$3) (heat\$3 near3 press\$3)))	USPAT; EPO; JPO; DERWENT	2003/07/14 16:28
-	9	((wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) with coat\$3) same ((press\$3 near3 coat\$3) (heat\$3 near3 press\$3))) and (top\$1coat\$3 same ("UV" ultra\$1violet))	USPAT; EPO; JPO; DERWENT	2003/07/14 16:37
-	51	((wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) with coat\$3) same ((press\$3 near3 coat\$3) (heat\$3 near3 press\$3)) same (seal\$4)	USPAT; EPO; JPO; DERWENT	2003/07/14 16:38
-	50	((wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) with coat\$3) same ((press\$3 near3 coat\$3) (heat\$3 near3 press\$3)) same (seal\$4)) not (((wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) with coat\$3) same ((press\$3 near3 coat\$3) (heat\$3 near3 press\$3))) and (top\$1coat\$3 same ("UV" ultra\$1violet)))	USPAT; EPO; JPO; DERWENT	2003/07/15 09:41